2015.6



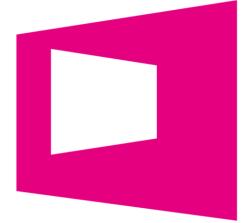
MAY 19, 2015

Axiomtek Announces Wide-voltage Range, Fanless 3.5" Intel® Atom ™-based Embedded SBC-CAPA840.



Designed for applications such as IoT/M2M-related, industrial control, self-serve terminal, digital signage, POS and kiosk, the Axiomtek CAPA840 allows dual views through multiple display outputs of HDMI, LVDS and VGA. Additionally, the compact embedded SBC adopts a ZIO connector and has two PCI Express Mini Card slots for flexible custom configurations. It features wide voltage DC-in +12V to +24V to make power input more flexible.





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2015
JUNE 2-6

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(Area I, 1st Floor, Nangang)
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National Pavilion
(Area N, Sky Dome, Nangang)
National Pavilion
(Area N, Sty Dome, Nangang)

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MAY 20, 2015

IEI Introduces Promising Future for the IoT, IEI Set to Reap the Benefits.

IEI's (3022) general manager, Jordan Jiang, is confident of the IPC's competitive advantage in rapid IoT development. He believes that with customers becoming more receptive towards adopting smart network management solutions, and with the demand for IPC being driven upwards by the robust growth of the IoT industry, there is potential for IPC-related companies to double in value in two years.





MAY 20, 2015

AAEON Debuts in the IoT Arena with AIOT-X1000.

Referred to as "AAEON Internet of Things", the AIOT-X1000 is powered by Intel's Quark X1000 Series SoC's to drive cost down while delivering substantial performance for interconnectivity between the broad array of devices in an IoT environment.





CROSSER
Acrosser Technology Co.,Ltd

MAY 17, 2015

Acrosser Kicks Off Sale of Its Latest Ultra Slim Vehicle Mount Computer Sale.

Acrosser has been an expert manufacturer of in-vehicle computing solutions for nearly a decade. For 2015, Acrosser is releasing its first slim Vehicle mount computer, AIV-HM76V1FL, to fulfill the growing market demand for a thinner hardware platform.

